



Product Change Notification

Change Notification #: 116324 - 00
Change Title: Intel® Compute Card CD1M3128MK,
PCN 116324-00, Product Design,
Documentation, Label, Product Marking,

BIOS update, Embedded Controller
Firmware update, updates to the RCM
logo and EAC logos
Date of Publication: June 26, 2018

Key Characteristics of the Change:
Product Design, Documentation, Label, Product Marking

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 20, 2018
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Description of Change to the Customer:

The Intel® Compute Card SKU listed in the products affected table below will have the following changes.

1. The BIOS will be updated from MKKBLY35.86A.0042 to MKKBLY35.86A.0051 for microcode security enhancement. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. The Embedded Controller Firmware version will be updated from V6.5A to V6.6D.

3. The Laser Etching for RCM logo will be updated to add R-NZ string. See attach photo.




Before	After
<p>Intel® Compute Card 7th Gen Intel® Core™ M3 Processor 4GB Memory, 128GB Storage INTEL CORPORATION</p> <p>This product contains an Approved module Model No. 8265D2W, FETEL No. RCFN8216-0897, Contains IC: 1000M-8265D2 Contains FCC ID: P098265D2, CAN ICES-3 (B)/NMB-3(B) 電腦卡 電腦卡, 型號 型號/Model: CD1M3128MK 直流輸入 直流輸入/Electrical Rating: 12V 1.67A CMIIT ID: 2017AJ5588</p> <p>CE FC VCCI RoHS UL 1000M-8265D2 CCAH17LP2840T4 L.T.E. Accessory E210882</p> <p>EAC NOM NYCE 1000M-8265D2 R 003-160129 技術基準認証済み T D160076003 の無線装置を内蔵</p> <p>ICASA TA-201711704 Approved MSIP-CRM-INT-8265D2W MSIP-RMM-CPU-CD1M3128MK</p> <p>SA JXXXXX-XXX XX-XXX-XXXXXX Made In China/中国製造 中国製造</p>	<p>Intel® Compute Card 7th Gen Intel® Core™ M3 Processor 4GB Memory, 128GB Storage INTEL CORPORATION</p> <p>This product contains an Approved module Model No. 8265D2W, FETEL No. RCFN8216-0897, Contains IC: 1000M-8265D2 Contains FCC ID: P098265D2, CAN ICES-3 (B)/NMB-3(B) 電腦卡 電腦卡, 型號 型號/Model: CD1M3128MK 直流輸入 直流輸入/Electrical Rating: 12V 1.67A CMIIT ID: 2017AJ5588</p> <p>CE FC VCCI RoHS UL 1000M-8265D2 CCAH17LP2840T4 L.T.E. Accessory E210882 R-NZ</p> <p>EAC NOM NYCE 1000M-8265D2 R 003-160129 技術基準認証済み T D160076003 の無線装置を内蔵</p> <p>ICASA TA-201711704 Approved MSIP-CRM-INT-8265D2W MSIP-RMM-CPU-CD1M3128MK</p> <p>SA JXXXXX-XXX XX-XXX-XXXXXX Made In China/中国製造 中国製造</p>

4. The EAC logo on booklet will be updated. See attach photo.


Before

Regulatory Information




NTC

Type Accepted
No.: ESD-1715685C



NTC

Type Accepted
No.: ESD-1716026C



D33025
RoHS

AGREE PAR L'ARNT MAROC


Numéro d'agrément: MR 12119 ANRT 2016
Date d'agrément: 22/06/2016

Connection and use of this communications equipment is permitted by the Nigerian Communication Commission

After



Regulatory Information



NTC


Type Accepted
No.: ESD-1715685C



NTC

Type Accepted
No.: ESD-1716026C





D33025
RoHS

AGREE PAR L'ARNT MAROC

Numéro d'agrément: MR 12119 ANRT 2016
Date d'agrément: 22/06/2016

Connection and use of this communications equipment is permitted by the Nigerian Communication Commission

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5. The EAC logo on carton label will be updated. See attach photo



Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

Intel anticipates no impact for the image update.

The updates to the RCM logo and the EAC logo have no impact on the functionality of the product. Customers should be aware of the change. Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Pre Change AA	Post Change TA	Post Change SA	Post Change AA
BLKCD1M3128MK	954730	J67772-102	J38723-504	J39466-503	J67772-103	J38723-505	J39466-504

PCN Revision History:

Date of Revision:
June 26, 2018

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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